

Instructions for completing the IBM Technology Group Recycler Information Form as required by Article 11 of the WEEE Directive

1. Review the table on page 2 and indicate the “positive presence” of materials and components as listed.
2. Choose from the list below as to the “**Product Family**”.

Centralized data processing	Mainframes	Minicomputers	Printer units
Other products and equipment for the collection, storage, processing, presentation or communication of information by electronic means	Printers	User terminals and systems	Other products or equipment of transmitting sound, images, or other information by telecommunications

3. This IBM WEEE Form will be used external to IBM. When completing information in the Component or Material categories on page 2, avoid using abbreviations, IBM development names or acronyms. If must use an acronym, please complete the acronym’s meaning to ensure it is understood by those who will utilize this WEEE Form. Also avoid using terminology that would not be easily understood by outside entities. All items must be answered or checked as appropriate.
4. When providing the location of a substance/component is requested, provide the part level (ex. Main board, housing, etc.) and part number no further details are needed.
5. List the type of battery; e.g. Lithium, Lithium Manganese Dioxide; battery PN, location and the battery weight (in grams)
6. For each capacitor >25mm in height or diameter, provide the electrolyte within the capacitor and the capacitor’s location.
7. Refractory ceramic fibres are: Man-made vitreous (silicate) fibres with random orientation with alkaline oxide and alkali earth oxide. They are sold under the trade names: Fiberfax, Cerwool, Kaowool, and others. There are three basic kinds of RCFs: - kaolin or clay-based products, where the clay is obtained in mining; - blends of alumina and silica with metal oxide additives (chromium (2-3%), zirconium (15-25%)); - high-purity blends of silica and alumina. RCFs are either blown or spun from molten clay (kaolin), or, molten alumina and silica mixtures (roughly 50% each). They are mainly used for insulation; reinforcement; and fire protection and other high-temperature uses.
8. Attach the form to the PEP.
9. Complete all of the following information for who completed the form on page 2:

Name	Dept No:	Phone Number	EMAIL Address	PEP No:	Date WEEE Form completed

PRODUCT INFORMATION	WEEE Product Category: IT and Telecommunications Equipment
Producer Name: Product Family: *(See page 1 for guidance) Brand Name:	Specific Product: Machine Type Number: Model Numbers: Part Number:

Component or Material	Check One	Location
Battery (Internal) containing Mercury (Hg) / NiCad /Lithium / Other	Yes [] No []	Battery Type: Battery Weight: Part Number: Location:
Backlighting lamps of LCD / TFT or similar screens containing Mercury (Hg)	Yes [] No []	
Mercury (Hg) in other applications **	Yes [] No []	
Cadmium **	Yes [] No []	
Gas discharge lamps	Yes [] No []	
Plastics containing brominated flame retardants other than in Circuit Card assemblies. ***	Yes [] No []	
Liquid Crystal Displays with a surface greater than 100 cm ²	Yes [] No []	
Capacitors with PCB's (polychlorinated biphenyls)	Yes [] No []	
Capacitors with a height > 25mm, diameter >25mm or proportionately similar in volume	Yes [] No []	Location:
If YES to the above question: Does the capacitor contain substances of concern (At this time the EU has defined substances of concern to include polychlorinated biphenyls)	Yes [] No []	
If NO to the above question: If the capacitor manufacturer has not deemed the electrolyte material to be proprietary, please provide the material substance used		Electrolyte material:
Asbestos	Yes [] No []	
Refractory ceramic fibres	Yes [] No []	
Radio-active substances	Yes [] No []	
Beryllium Oxide	Yes [] No []	
Other forms of Beryllium	Yes [] No []	
Gasses – which fall under Regulation (EC) 2037/2000 and all hydrocarbons (HC) (Type of Gas, Properties, Volume and/or weight)	Yes [] No []	
Components with pressurized gas which need special attention (Pressure > 1,5 bar) ***** (Type of Gas, Pressure level, Discharge method)	Yes [] No []	
Liquids ***** If volume > 10 cl (or equivalence in weight, e.g. for PCB, oil) (Type of liquid, Discharge method)	Yes [] No []	
Mechanical components that store mechanical energy (ie. springs) or equivalent parts which need special attention ***** (Diameter >10 mm and height >25 mm or proportionally similar volume and expanding)	Yes [] No []	

** Substances are considered to be in the product if present above the levels specified in Commission Decision 2005/618/EC related to Directive 2002/95/(EC) (RoHS Directive) or if their use is permitted through exceptions in the Annex of Directive 2002/95(CE)

*** To be coherent with industry current standards and practices on tracking of plastic parts, Directive 2002/96 (EC) Annex II requirement is understood to practice on plastic parts that weight more than 25 g.

**** Substance of concern other than PCB, to be specified/addressed further in the context of Directive 2002/96 Annex II national requirements and European developments.

***** Needs of equivalent nature as those for maintenance, service manuals and installation for safety purposes.

Information provided in this environmental statement is, to our knowledge and belief, correct as of the date indicated on this document. Information concerning materials and chemicals contained in IBM's products is a restatement of results from data analysis, tests and/or supplier inquiries conducted by IBM. This information is based exclusively on those results and is provided "AS IS." IBM makes no representations, guarantees, assurances or warranties, whether expressed or implied, regarding the accuracy of such results or the content of third party products incorporated into IBM's products. This statement does not modify, alter, or change the terms of the agreement under which you purchase IBM products. All warranties and limitations set forth in the relevant agreement shall continue to apply. Contact an IBM Account Representative for more information.